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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





July 2013

Common Mode Filters

For high-speed differential signal line (USB2.0, LVDS, etc.)

TCM-G series

TCM0605G TCM0806G TCM1608G [0202 inch]* [0302 inch] [0603 inch]

* Dimensions Code JIS[EIA]

protection circuit/device or providing backup circuits in your equipment.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDERS ○ The storage period is less than 6 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 20 to 70% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. O Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.). O Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C. O Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur. O When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions. Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design. Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. ○ Use a wrist band to discharge static electricity in your body through the grounding wire. O Do not expose the products to magnets or magnetic fields. O Do not use for a purpose outside of the contents regulated in the delivery specifications. O The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us. (1) Aerospace/Aviation equipment (8) Public information-processing equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (9) Military equipment (3) Medical equipment (10) Electric heating apparatus, burning equipment (4) Power-generation control equipment (11) Disaster prevention/crime prevention equipment (5) Atomic energy-related equipment (12) Safety equipment (6) Seabed equipment (13) Other applications that are not considered general-purpose applications (7) Transportation control equipment When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing

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Common Mode Filters For high-speed differential signal line

(USB2.0, LVDS, etc.)

Product compatible with RoHS directive Halogen-free Compatible with lead-free solders

Overview of the TCM-G Series

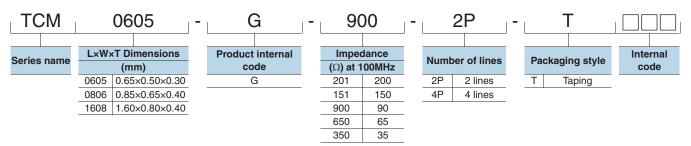
FEATURES

- O Thin-film common mode filter based on the thin-film processing techniques and material technology cultivated from HDD head manufacturing.
- O Has EMC suppression by achieving wide frequency range (cutoff frequency of 3GHz or higher) differential mode transmission while ensuring common mode impedance with virtually no affect on the high-speed differential transmission line signal.
- ◯ Lineup includes the compact 0605 size (0.65×0.50×0.30mm) and 1608 (1.60×0.80×0.40mm) array type, etc.

APPLICATION

Noise countermeasure for high-speed differential interfaces (USB2.0, LVDS, MIPI, etc.) for mobile devices and general consumer products such as smart phones, tablets, digital cameras, and portable music players.

PART NUMBER CONSTRUCTION



OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range			
Туре	Operating temperature	Storage temperature*	Package quantity	Individual weight	
	(°C)	(°C)	(pieces/reel)	(mg)	
TCM0605G	-25 to +85	-25 to +85	10,000	0.5	
TCM0806G –25 to +85		-25 to +85	10,000	1.0	
TCM1608G	-25 to +85	-25 to +85	4,000	4.0	

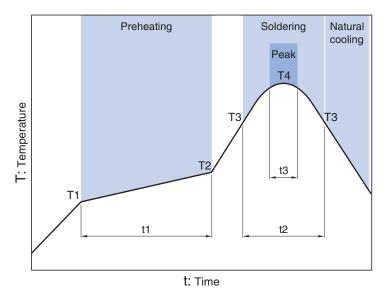
* The Storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://www.tdk.co.jp/rohs/
 Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

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[•] All specifications are subject to change without notice.

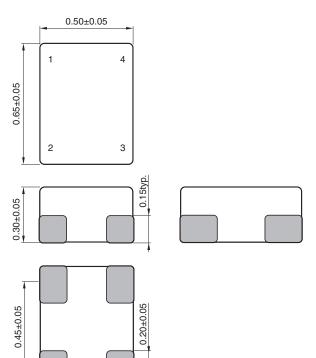
RECOMMENDED REFLOW PROFILE



Preheating Soldering Peak Temp. Temp. Time Temp. Time Time T1 **T2** t1 Т3 t2 **T**4 t3 150°C 180°C 60 to 120s 230°C 10 to 30s 245°C 5s max.

TCM-G series TCM0605G Type

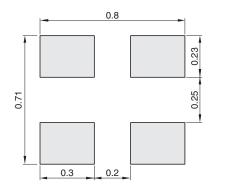
SHAPE & DIMENSIONS



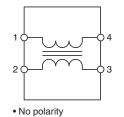
Dimensions in mm

RECOMMENDED LAND PATTERN

0.15±0.05



CIRCUIT DIAGRAM



Dimensions in mm

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ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Common mod [at 100MHz]	e impedance	DC resistance - (Ω)[1 line]	Rated current (A)max.	Rated voltage (V)max.	Insulation resistance	Part No.
(Ω)	Tolerance		(A)max.	(V)max.	(MΩ)min.	
65	±20%	2.7±30%	0.1	10	10	TCM0605G-650-2P-T
90	±20%	3.0±30%	0.1	10	10	TCM0605G-900-2P-T

○ Measurement equipment

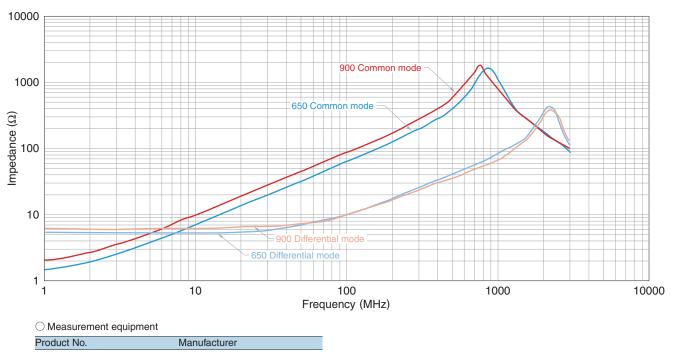
Measurement item	Product No.	Manufacturer
Common mode impedance	4291A	Agilent Technologies
DC resistance	4338A	Agilent Technologies
Insulation resistance	4339A	Agilent Technologies

* Equivalent measurement equipment may be used.

TCM-G series TCM0605G Type

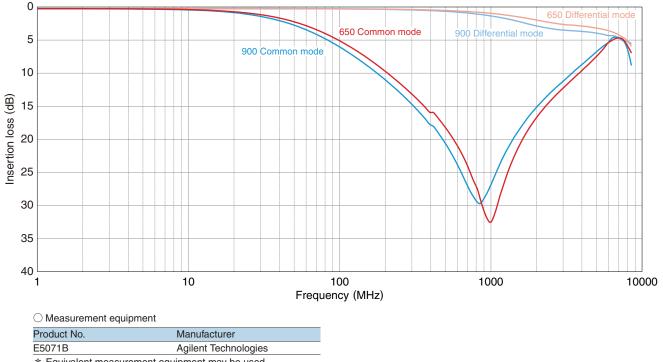
ELECTRICAL CHARACTERISTICS

□ IMPEDANCE VS. FREQUENCY CHARACTERISTICS



E4991A Agilent Technologies * Equivalent measurement equipment may be used.

□ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



* Equivalent measurement equipment may be used.

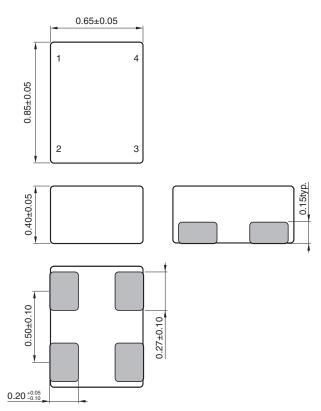
*****<u>⊗</u>TDK*

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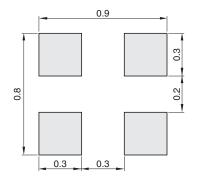
EMC Components

TCM-G series TCM0806G Type

SHAPE & DIMENSIONS

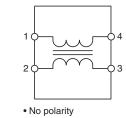


RECOMMENDED LAND PATTERN



ERN CIRCUIT DIAGRAM

Dimensions in mm



Dimensions in mm

TCM-G series TCM0806G Type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Common mode impedance [at 100MHz]		DC resistance (Ω) [1 line]		Rated voltage (V)max.	Insulation resistance	Part No.
(Ω)	Tolerance		(A)max.	(V)IIIax.	(M Ω)min .	
35	±30%	1.15±30%	0.10	10	10	TCM0806G-350-2P-T
65	±20%	2.50±30%	0.10	10	10	TCM0806G-650-2P-T
90	±20%	2.70±30%	0.10	10	10	TCM0806G-900-2P-T
150	±20%	3.50±30%	0.05	10	10	TCM0806G-151-2P-T

\bigcirc Measurement equipment

Measurement item	Product No.	Manufacturer	
Common mode impedance	4291A	Agilent Technologies	
DC resistance	4338A	Agilent Technologies	
Insulation resistance	4339A	Agilent Technologies	

* Equivalent measurement equipment may be used.

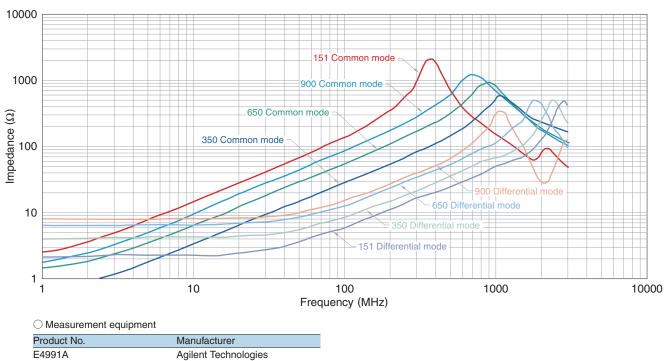
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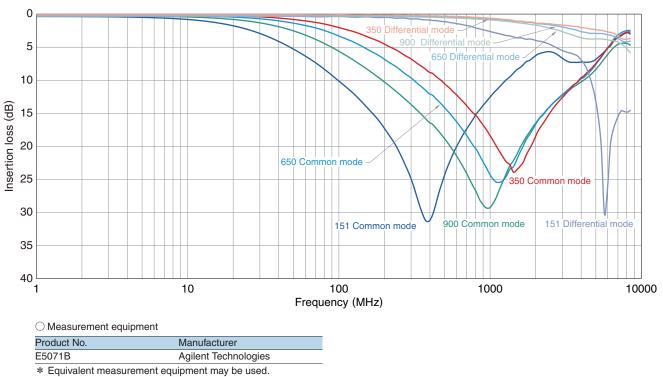
TCM-G series TCM0806G Type

ELECTRICAL CHARACTERISTICS

□ IMPEDANCE VS. FREQUENCY CHARACTERISTICS



* Equivalent measurement equipment may be used.



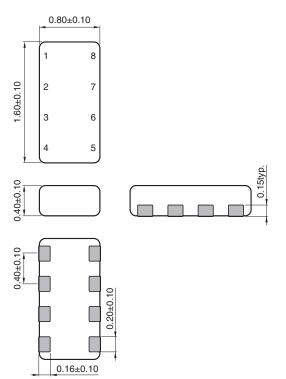
□ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS

• All specifications are subject to change without notice.

*****<u>⊗</u>TDK*

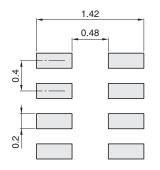
TCM-G series TCM1608G Type

SHAPE & DIMENSIONS



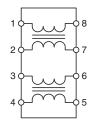
Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

CIRCUIT DIAGRAM



No polarity

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(11/14)



ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Common mode impedance [at 100MHz]		DC resistance	DC resistance Rated current (Ω)[1 line] (A)max.		Insulation resistance	Part No.
(Ω)	Tolerance		(A)IIIax.	(V)max.	(M Ω)min.	
35	±30%	0.85±30%	0.10	5	10	TCM1608G-350-4P-T
65	±20%	1.30±30%	0.10	5	10	TCM1608G-650-4P-T
90	±20%	1.50±30%	0.10	5	10	TCM1608G-900-4P-T
200	±20%	4.00±30%	0.05	5	10	TCM1608G-201-4P-T

\bigcirc Measurement equipment

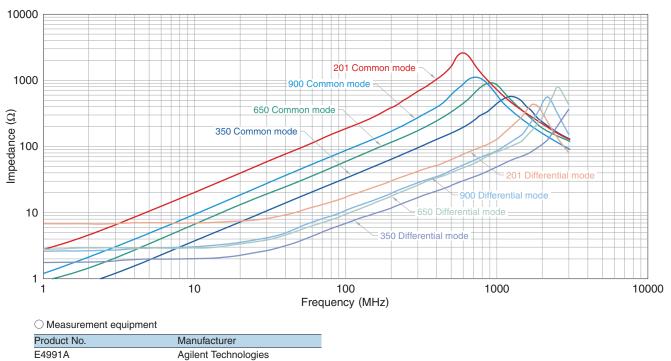
Measurement item	Product No.	Manufacturer	
Common mode impedance	4291A	Agilent Technologies	
DC resistance	4338A	Agilent Technologies	
Insulation resistance	4339A	Agilent Technologies	

* Equivalent measurement equipment may be used.

TCM-G series TCM1608G Type

ELECTRICAL CHARACTERISTICS

□ IMPEDANCE VS. FREQUENCY CHARACTERISTICS



* Equivalent measurement equipment may be used.

0 201 Differential mode 5 900 Differential mo 10 650 Differential mode Insertion loss (dB) 15 20 900 Common mode 350 Common mode 25 650 Common mode 30 201 Common mode 35 40 10 100 1000 10000 1 Frequency (MHz) O Measurement equipment Product No. Manufacturer E5071B Agilent Technologies * Equivalent measurement equipment may be used.

□ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS

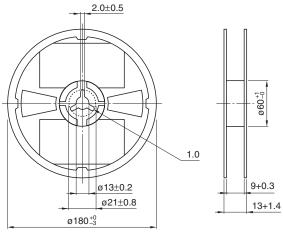
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EMC Components

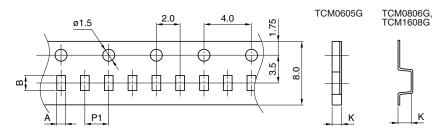
TCM-G series Packaging style

REEL DIMENSIONS

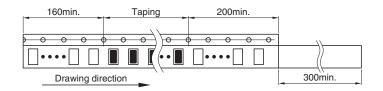


Dimensions in mm

TAPE DIMENSIONS



Dimensions in mi						
Туре	A	В	P1	K		
TCM0605G	0.63	0.77	2.0	0.35		
TCM0806G	0.74	0.94	2.0	0.50		
TCM1608G	1.00	1.80	4.0	0.50		



Dimensions in mm